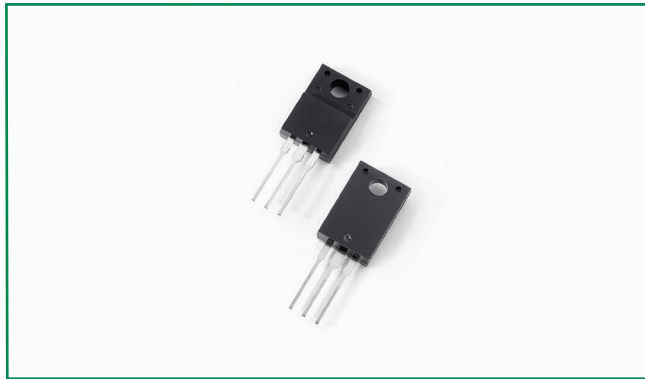
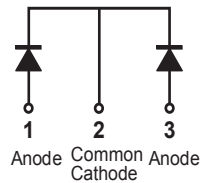


MBRF30100CTP



Pin out



Description

Littelfuse MBR series Schottky Barrier Rectifier is designed to meet the general requirements of commercial applications by providing high temperature, low leakage and low V_F products.

It is suitable for high frequency switching mode power supply, free-wheeling diodes and polarity protection diodes.

Features

- High junction temperature capability
- Guard ring for enhanced ruggedness and long term reliability
- Low forward voltage drop
- High frequency operation
- Common cathode configuration in electrically isolated ITO-220AB package

Applications

- Switching mode power supply
- Free-wheeling diodes
- DC/DC converters
- Polarity protection diodes

Maximum Ratings

Parameters	Symbol	Test Conditions	Max	Unit
Peak Inverse Voltage	V_{RWM}	-	100	V
Average Forward Current	$I_{F(AV)}$	50% duty cycle @ $T_C = 133^\circ\text{C}$, rectangular wave form	15 (per leg) 30 (total device)	A
Peak Repetitive Forward Current(per leg)	I_{FRM}	Rated V_R square wave, 20KHz $T_C = 133^\circ\text{C}$	20	A
Peak One Cycle Non-Repetitive Surge Current (per leg)	I_{FSM}	Surge applied at rated load conditions halfwave, single phase, 60Hz	150	A

Electrical Characteristics

Parameters	Symbol	Test Conditions	Max	Unit
Forward Voltage Drop (per leg) *	V_{F1}	@ 15A, Pulse, $T_J = 25^\circ\text{C}$	0.85	V
	V_{F2}	@ 15A, Pulse, $T_J = 125^\circ\text{C}$	0.70	
Reverse Current (per leg) *	I_{R1}	@ $V_R = \text{rated } V_R$, $T_J = 25^\circ\text{C}$	1.0	mA
	I_{R2}	@ $V_R = \text{rated } V_R$, $T_J = 125^\circ\text{C}$	6.0	
Junction Capacitance (per leg)	C_T	@ $V_R = 5\text{V}$, $T_C = 25^\circ\text{C}$ $f_{SIG} = 1\text{MHz}$	400	pF
Typical Series Inductance (per leg)	L_S	Measured lead to lead 5 mm from package body	8.0	nH
Voltage Rate of Change	dv/dt		10,000	V/ μs
RSM Isolation Voltage ($t = 1.0$ second, R. H. < 30%, $T_A = 25^\circ\text{C}$)	V_{ISO}	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction.	4500	V
		Clip mounting, the epoxy body is inside the heatsink.	3500	
		Screw mounting, the epoxy body is inside the heatsink.	1500	

* Pulse Width < 300 μs , Duty Cycle < 2%

Thermal-Mechanical Specifications

Parameters	Symbol	Test Conditions	Max	Unit
Junction Temperature	T_J		-55 to +150	°C
Storage Temperature	T_{stg}		-55 to +150	°C
Maximum Thermal Resistance Junction to Case	R_{thJC}	DC operation	2.0	°C/W
Maximum Thermal Resistance, Case to Heat Sink	R_{thJA}	DC operation	50	°C/W
Maximum Thermal Resistance, Case to Heat Sink	R_{thCS}	Mounting surface, smooth and greased	0.5	°C/W
Approximate Weight	wt		2	g
Case Style	ITO-220AB			

Figure 1: Typical Forward Characteristics

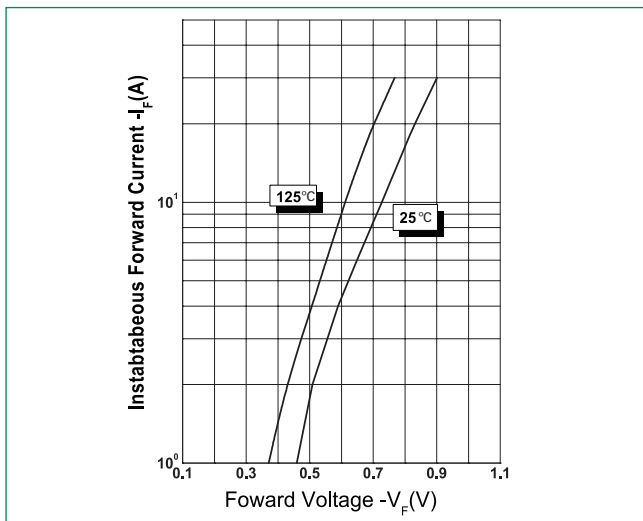


Figure 2: Typical Reverse Characteristics

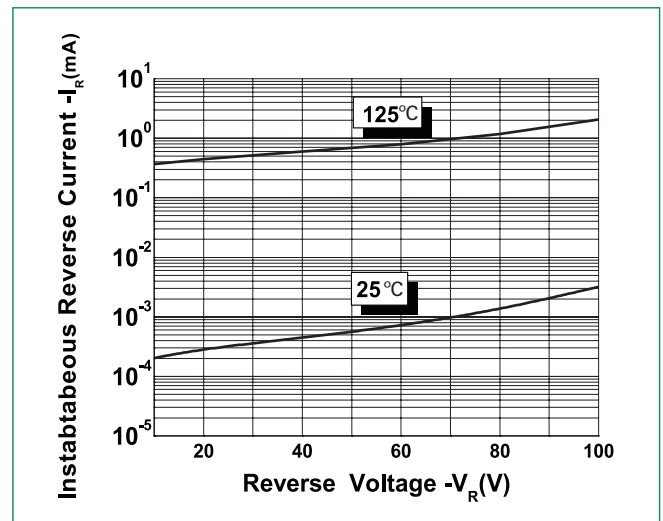
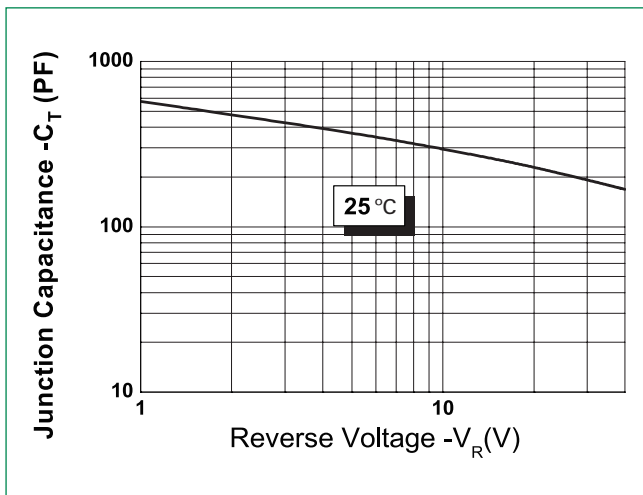
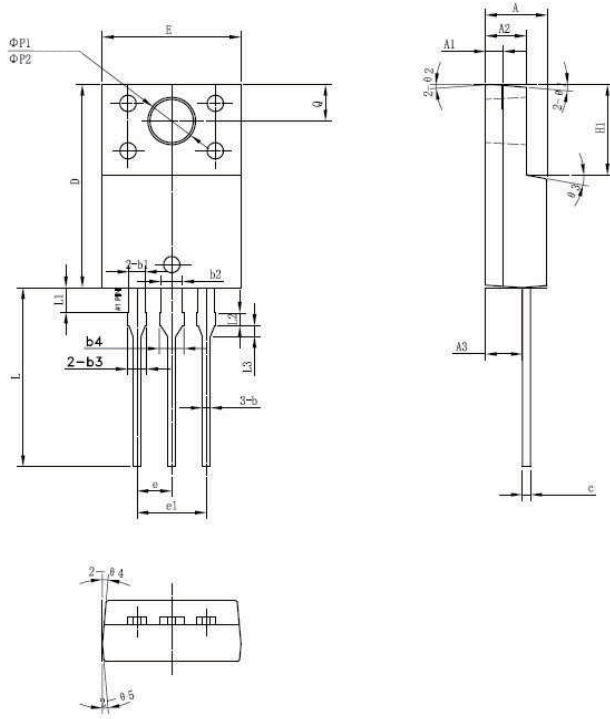


Figure 3: Typical Junction Capacitance



Dimensions- ITO-220AB

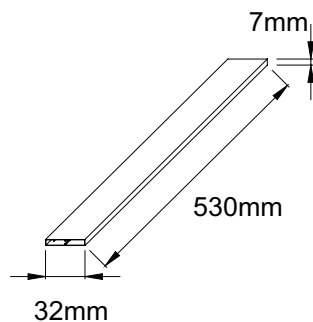


Symbol	Millimeters		
	Min	Typ	Max
A	4.30	4.50	4.70
A1	1.10	1.30	1.50
A2	2.80	3.00	3.20
A3	2.50	2.70	2.90
b	0.50	0.60	0.75
b1	1.10	1.20	1.35
b2	1.50	1.60	1.75
b3	1.20	1.30	1.45
b4	1.60	1.70	1.85
c	0.55	0.60	0.75
D	14.80	15.00	15.20
E	9.96	10.16	10.36
e		2.55	
e1		5.10	
H1	6.50	6.70	6.90
L	12.70	13.20	13.70
L1	1.60	1.80	2.00
L2	0.80	1.00	1.20
L3	0.60	0.80	1.00
ØP1	3.30	3.50	3.70
ØP2	2.99	3.19	3.39
Q	2.50	2.70	2.90
θ1		5°	
θ2		4°	
θ3		10°	
θ4		5°	
θ5		5°	

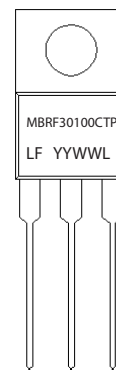
Packing Options

Part Number	Marking	Packing Mode	M.O.Q
MBRF30100CTP	MBRF30100CTP	50pcs / Tube	1000

Tube Specification



Part Numbering and Marking System



MBR = Device Type
 F = Package type
 30 = Forward Current (30A)
 100 = Reverse Voltage (100V)
 CTP = Configuration
 LF = Littelfuse
 YY = Year
 WW = Week
 L = Lot Number